502448774 08/07/2013

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yasutaka TSUTSUI	05/29/2013
Shingo TERASAKI	05/29/2013

RECEIVING PARTY DATA

Name:	SEKISUI PLASTICS CO., LTD.,
Street Address:	4-4, Nishitenma 2-chome, Kita-ku, Osaka-shi,
City:	Osaka
State/Country:	JAPAN
Postal Code:	5300047

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13984040

CORRESPONDENCE DATA

Fax Number: 7037161180

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 703-716-1191

Email: gbpatent@gbpatent.com

Correspondent Name: GREENBLUM & BERNSTEIN, P.L.C.

Address Line 1: 1950 ROLAND CLARKE PLACE

Address Line 4: RESTON, VIRGINIA 20191

ATTORNEY DOCKET NUMBER:	P44349
NAME OF SUBMITTER:	Daniel B. Moon
Signature:	/Daniel B. Moon/
Date:	08/07/2013

Total Attachments: 2

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PATENT REEL: 030956 FRAME: 0555

ASSIGNMENT

WHEREAS,

Yasutaka TSUTSUI, a citizen of <u>Japan</u>, whose post office address is <u>c/o SEKISUI PLASTICS CO.</u>, <u>LTD.</u>, 1259 <u>Minakuchicho Izumi</u>, <u>Koka-shi</u>, <u>Shiga 5280056 Japan</u> and <u>Shingo TERASAKI</u>, a citizen of <u>Japan</u>, whose post office address is <u>c/o SEKISUI PLASTICS CO.</u>, <u>LTD.</u>, 1259 <u>Minakuchicho Izumi</u>, <u>Koka-shi</u>, <u>Shiga 5280056 Japan</u>

hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

"EXPANDED COMPOSITE POLYSTYRENE-BASED RESIN PARTICLES AND EXPANDED MOLDED ARTICLE THEREOF"

for which they have jointly executed an application for Letters Patent for the	United States which
was filed in the United States Patent and Trademark Office on	and was awarded
Application No	

OPTIONAL

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the attorneys of record in this application including Neil F. Greenblum, Reg. No. 28,394, Bruce H. Bernstein, Reg. No. 29,027, Arnold Turk, Reg. No. 33,094, James L. Rowland, Reg. No. 32,674, Stephen M. Roylance, Reg. No. 31,296, Leslie J. Paperner, Reg. No. 33,329, William Pieprz, Reg. No. 33,630, Robert W. Mueller, Reg. No. 35,043 and William E. Lyddane, Reg. No. 41,568, of the firm Greenblum & Bernstein, P.L.C., whose address is 1950 Roland Clarke Place, Reston, Virginia 20191, to insert here in parenthesis (Application No. _________, filed _________) the filing date and application number of said application when known.

AND WHEREAS, <u>SEKISUI PLASTICS CO.,LTD.</u>, a corporation organized and existing under the laws of the State of <u>Japan</u>, whose post-office address is <u>4-4</u>, <u>Nishitenma 2-chome</u>, <u>Kita-ku</u>, <u>Osaka-shi</u>, <u>Osaka 5300047 Japan</u>, hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.

NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights to sue for past and future infringement thereunder, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and

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all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

(Date) = 9 / 5 / 20 /3

(Date) 29 / 5 / 2013Shingo Tevasaki Shingo TERASAKI

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